

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1114	257/529.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 09:48
L2	1479	257/536.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 09:48
L3	514	257/537.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 09:48
L4	327	337/159.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 09:48
L5	251	337/297.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 09:48
L6	2803	257/773.cds.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 09:50
L7	6223	I1 or I2 or I3 or I4 or I5 or I6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 09:50
L8	12	I7 and fuse and (multi- layered) and (single adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 09:50
L9	0	fuse with layered with circuit with conductive with interlayer with electrode with pad. cdms.	US-PGPUB	OR	ON	2008/05/27 09:53

S1	394	fuse and (multi-layered) and (single adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/19 07:07
S2	0	S1 and ((fuse adj circuit) with (plural or plurality))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/23 13:34
S3	8	S1 and (fuse adj circuit) and (plural or plurality)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/23 13:37
S4	0	S1 and (multi-layered adj fuse)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/23 13:37
S5	18	S1 and (multi-layered with fuse)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/23 13:37
S6	107	fuse with (single adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/23 14:02
S7	62	S6 and circuit	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/23 14:03
S8	0	fuse and ((multi-layered) with (single adj layer) with insulator)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/26 15:45
S9	2	fuse and ((multi adj layer) with (single adj layer) with insulator)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/26 15:46
S10	506	fuse and (multi-layered) and (single adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/26 15:49

S11	9136	fuse with semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/26 15:49
S12	60	fuse with semiconductor with ((multi or multiple or plural) adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/26 15:51
S13	871	257/529.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/26 16:22
S14	11	S13 and S10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/22 00:18
S15	542	fuse and (multi-layered) and (single adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/22 00:18
S16	920	257/529.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/22 00:18
S17	11	S16 and S15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/22 00:18
S18	11	S17 and (pads or contacts or electrodes)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/23 10:38
S19	548	fuse and (multi-layered) and (single adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/23 10:48
S20	497	S19 and (((bonding or bond) adj pads) or contacts or electrodes)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/23 10:40

S21	37	S19 and ((bonding or bond) adj pads)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/23 10:48
S22	660	((bonding or bond) adj pads) with fuse	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/23 10:48
S23	3	S22 and (multi-layered) and (single adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/23 10:48
S24	14	fuse with (multi adj layer) with (single adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/19 07:09
S25	0	S24 and cantilever	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/19 07:11
S26	87	fuse with cantilever	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/19 07:15
S27	16	semiconductor and (fuse with cantilever)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/19 07:15
S28	17	("20020060352"   "20020079552"   "20030038338"   "20040038458"   "20040046231"   "4331947"   "5726621"   "6853050").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/25 14:08

5/ 27/ 08 9:53:51 AM

C:\Documents and Settings\EWojciechowicz\My Documents\EAST\Workspaces  
\10673392.wsp